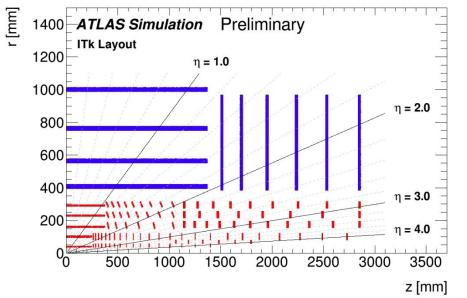
# **ATLAS ITk strip detector introduction**



Example of design choices made to meet requirements and schedule:

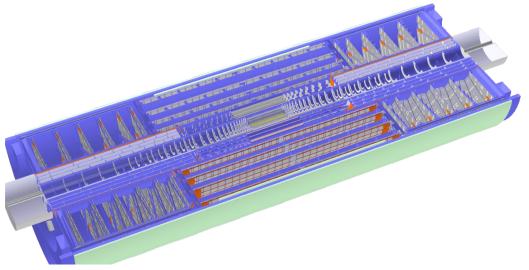
- Local, on-module DC-DC
- Advanced cooling: Manifolded, CO2-based
- Honeycomb structures for module support
- Industry standard design rules, simplified construction
- Assembly and testing happening at multiple sites worldwide

ITk Strip system will consist of:

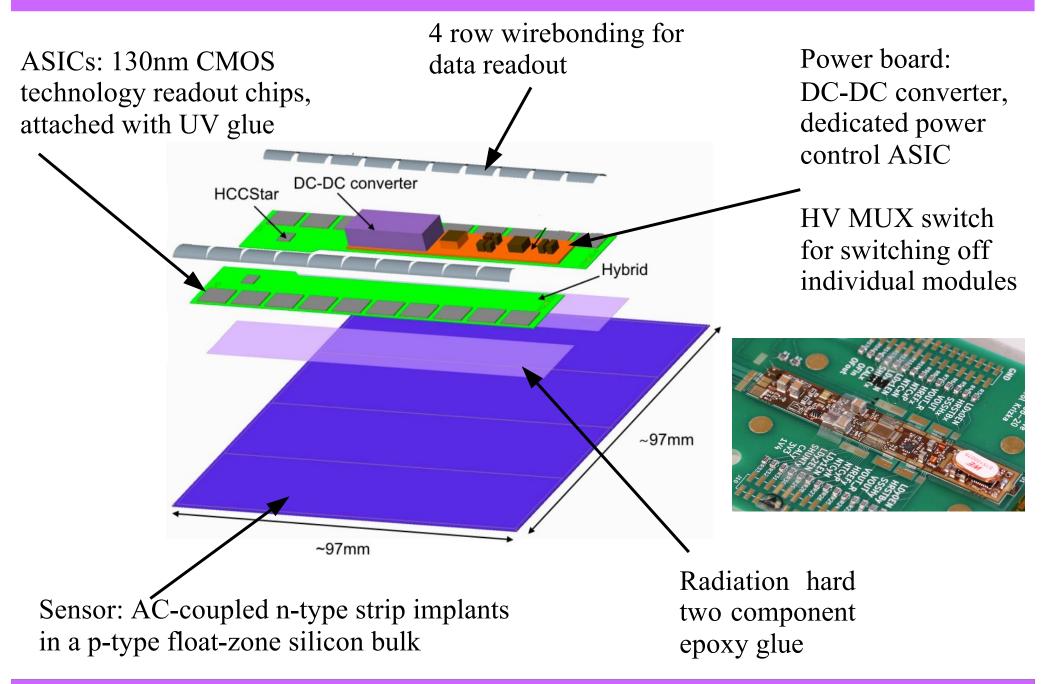
- 4 barrel cylinders and 6 disks per end cap
- 165 m<sup>2</sup> of silicon (current Inner Detector: 61 m<sup>2</sup>)
- ~18 k modules (current: ~4k modules)
- ~60 million channels (current: ~6 million)

Main requirements for design:

• radiation hardness, high granularity, readout speed that meets increased trigger rates, low material budget



## **ITk strip detector introduction II**



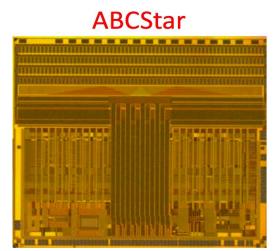
#### 2019--> 2023

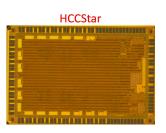
# ASICs

- ABCStar & HCCStar: data readout & control on the hybrids
- AMAC: monitoring and control chip for power board
- Star  $\rightarrow$  latest ASIC generation with central readout scheme for higher trigger rate/bandwidth
- Chips fabricated at Global Foundries in 130 nm CMOS technology
- 640 MHz clock, 256 channel per ASIC, Region Of Interest trigger options, unloaded noise ~400 electrons

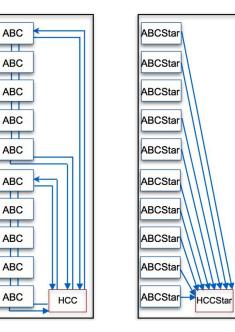
### Quality Control/Quality Assurance tasks

- Reception quality control (wafer probing) to identify good dies
- Metrology and visual inspection of diced ASICs
- Irradiation qualification of ASICs for new designs







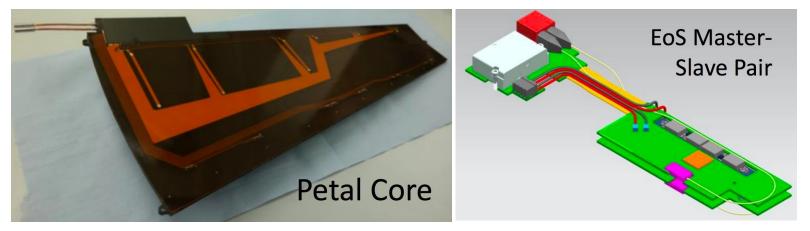


#### Karola Dette

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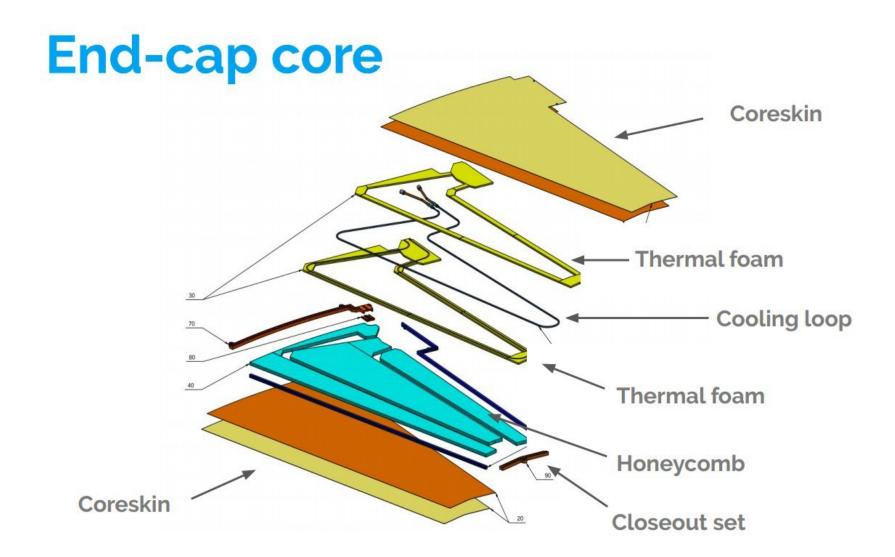
# **ITk strip detector introduction II**

- Substructure for barrel cylinders called staves, endcap disks made of petals
- These local structures (LS) provide mechanical support & cooling (cores) + powering & readout (bus tapes)
- Staves and petals are connected to off-detector electronics through an End-Of-Substructure (EoS) board





### **Petal core**

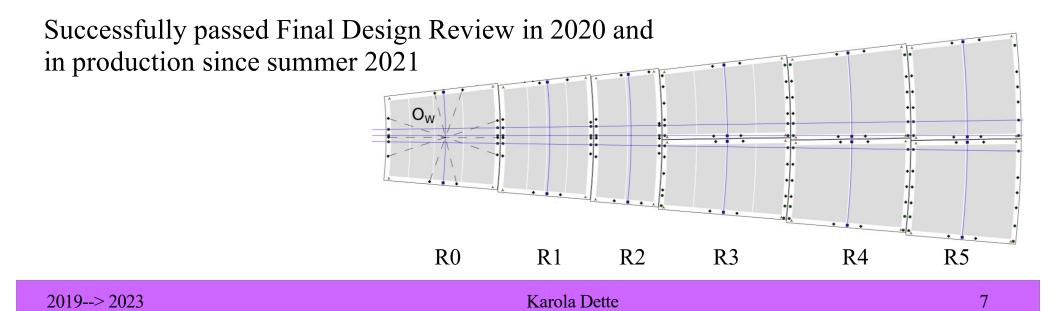


## Sensors

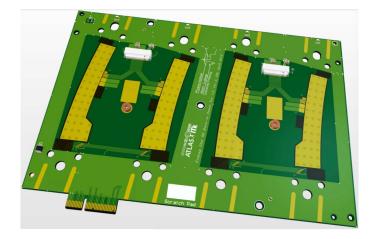
- p-type FZ silicon with n-type strip implants
- depletion voltage  $\leq$  350V, maximum operation voltage 500V, slim edge of ~500  $\mu$ m for higher track acceptance

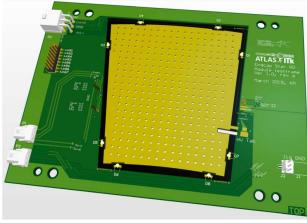
Intensive testing campaign to verify prototype design:

- Testing of various designs developed over more than 10 years
- 5 Irradiation sources, 15 institutes testing the sensors
- 8 different shapes of sensor (2 barrel, 6 endcap)



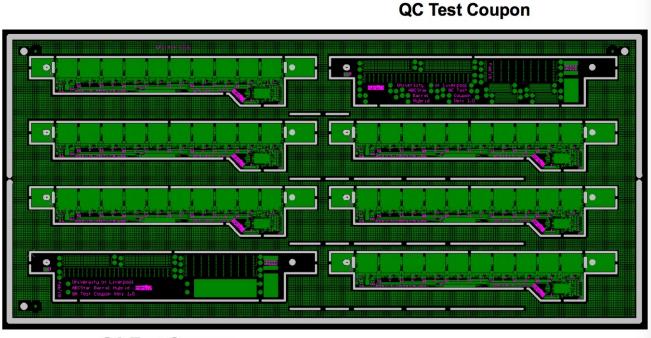
## Hybrids and test frames





- Hybrid (4 layer flex circuit), test frame and burn-in panel designs now final
- 15 different hybrid types
  2 barrel
  13 endcap

Test coupons allow tQA/QC measurements (thickness, resistance, bond pull tests, thermal cycling, delamination



**QA Test Coupon** 

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# **Modules – History of Prototyping**

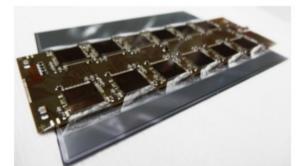
### Module assembly has developed over

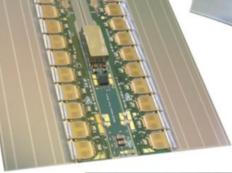
past few years

- ABCN modules (2008-2016)
  - $\sim 50$  barrel modules
  - ~ 30 petalet modules
- ABC130 modules (2015-2019)
  - $\sim 80$  barrel modules
  - $\sim 30$  Endcap modules
- Countless trials with plastic and glass dummies
- ABCStar modules (2019-onwards)
  - 50 LS & 100 SS barrel modules
  - 30 Endcap modules



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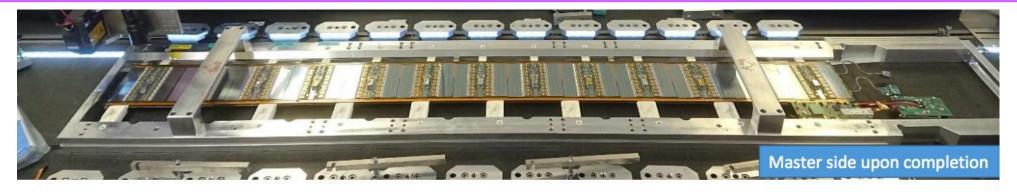


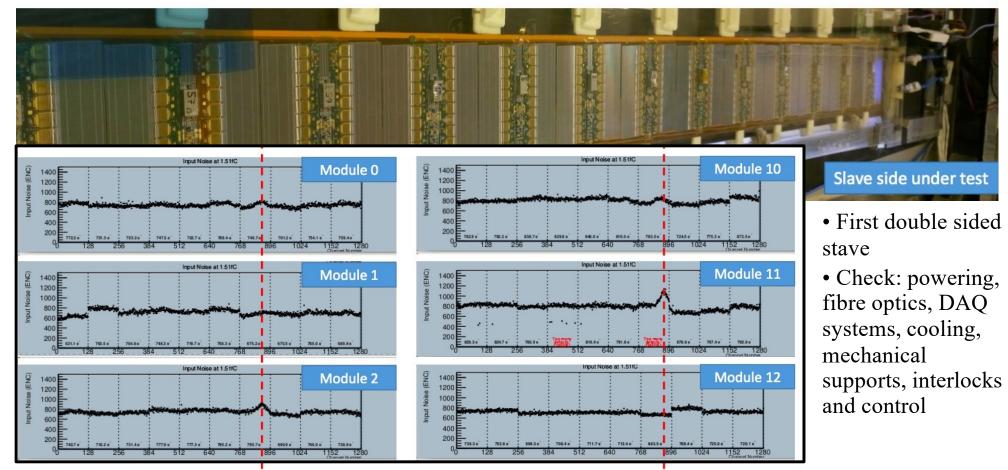
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### System test



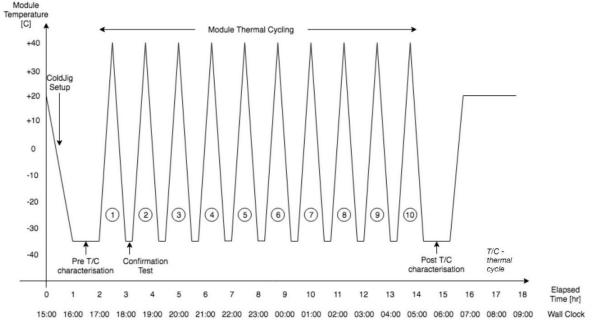


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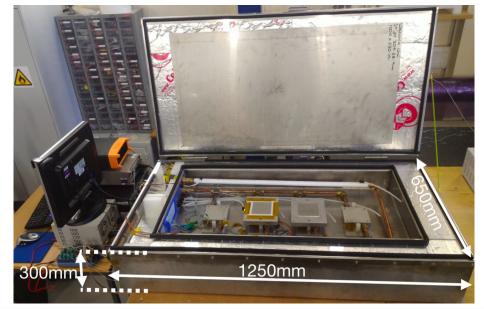
# **Module QC**

### QC for modules

- Hybrid crate for 100 hour burn-in (now operating here)
- Module test box for thermal cycling of modules (operating at UofT)
- Pre-production almost finished in hand and being tested
- Production readiness review in July 2023 → start of production







2019--> 2023

# **Project organisation**

- Complex production model with 51 institutes worldwide building & testing detector parts Need
- to closely keep track of procedures and scheduling
- Exercising about 75% of this parts flow in pre-production Remaining sites will come online through end of 2023.
- Celestica/UofT ready to start production when parts released (after final review)

